SiHP22N65E

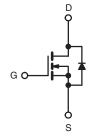
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	700			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.18		
Q _g max. (nC)	110			
Q _{gs} (nC)	15			
Q _{gd} (nC)	32			
Configuration	Single			

то-220АВ



N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of

compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SiHP22N65E-E3
Lead (Pb)-free and Halogen-free	SiHP22N65E-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	650	V		
Gate-Source Voltage			V _{GS}	± 30	V		
Continuous Drain Current (T _J = 150 °C)	V at 10 V	T _C = 25 °C T _C = 100 °C	1	22			
	V _{GS} at 10 V	T _C = 100 °C	I _D	14	А		
Pulsed Drain Current ^a			I _{DM}	56			
Linear Derating Factor				1.8	W/°C		
Single Pulse Avalanche Energy ^b			E _{AS}	691	mJ		
Maximum Power Dissipation			P _D	227	W		
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	T _J = 125 °C		70				
Reverse Diode dV/dt ^d			dV/dt	26	V/ns		
Soldering Recommendations (Peak Temperature) ^c	for 10 s			300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 7 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

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RoHS

HALOGEN



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THERMAL RESISTANCE RAT									
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-	- 62			°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.55							
SPECIFICATIONS (T _J = 25 °C,	unless otherwi	ise noted)							
PARAMETER	SYMBOL	L.	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI	
Static		-			1	ł	ł	ļ	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 2	250 µA	650	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.74	-	V/°0	
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	250 µA	2	-	4	V	
Octo Course Lockson			$V_{GS} = \pm 20$	V	-	-	± 100	nA	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30 \text{ V}$			-	-	± 1	μA	
Zaus Osta Maltana Dusia Orimont		$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1			
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 520 \	/, V _{GS} = 0 \	/, T _J = 125 °C	-	-	10	μA	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I	_D = 11 A	-	0.15	0.18	Ω	
Forward Transconductance	9 _{fs}	V _D	_S = 8 V, I _D :	= 5 A	-	6.7	-	S	
Dynamic		·			•	•		•	
Input Capacitance	C _{iss}		V _{GS} = 0 V,		-	2415	-		
Output Capacitance	C _{oss}	$V_{DS} = 100 V,$ f = 1 MHz		-	118	-	pF		
Reverse Transfer Capacitance	C _{rss}			-	4	-			
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V_{DS} = 0 V to 520 V, V_{GS} = 0 V		-	89	-			
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	307	-			
Total Gate Charge	Qg				-	73	110		
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	V _{GS} = 10 V I _D = 11 A, V _{DS} = 520 V		-	15	-	nC	
Gate-Drain Charge	Q _{gd}				-	32	-		
Turn-On Delay Time	t _{d(on)}				-	22	45		
Rise Time	t _r	V _{DD} =	V_{DD} = 520 V, I_{D} = 11 A, V_{GS} = 10 V, R_{g} = 9.1 Ω		-	33	66	ns	
Turn-Off Delay Time	t _{d(off)}				-	73	110		
Fall Time	t _f			-	38	76			
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.64	-	Ω		
Drain-Source Body Diode Characterist	cs								
Continuous Source-Drain Diode Current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	22	A		
Pulsed Diode Forward Current	I _{SM}			-	-	56			
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	-	1.2	V		
Reverse Recovery Time	t _{rr}				-	400	-	ns	
Reverse Recovery Charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 11 \text{ A},$ dI/dt = 100 A/µs, V _R = 400 V		-	5.9	-	μC		
Reverse Recovery Current	I _{RRM}			_	20	_	A		

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. C_{oss(tr)} is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

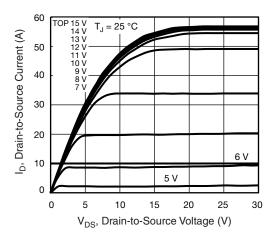


Fig. 1 - Typical Output Characteristics

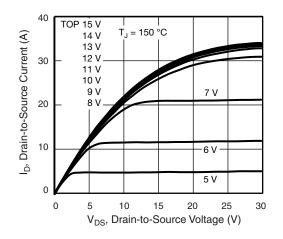


Fig. 2 - Typical Output Characteristics

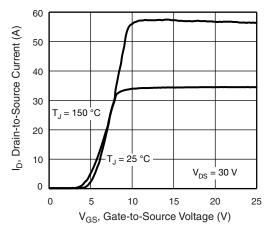


Fig. 3 - Typical Transfer Characteristics

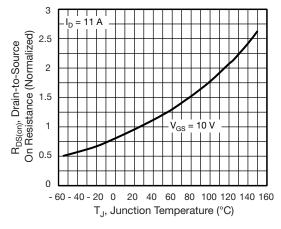


Fig. 4 - Normalized On-Resistance vs. Temperature

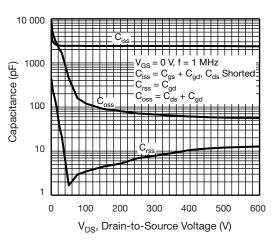


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

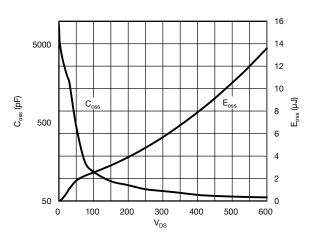


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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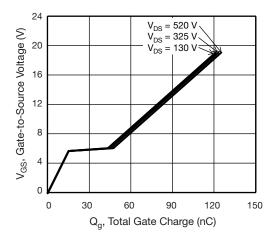


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

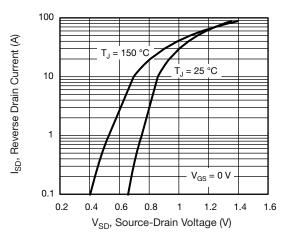


Fig. 8 - Typical Source-Drain Diode Forward Voltage

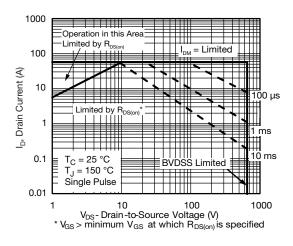


Fig. 9 - Maximum Safe Operating Area

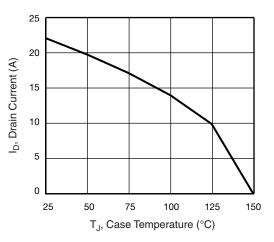


Fig. 10 - Maximum Drain Current vs. Case Temperature

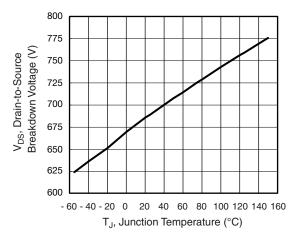
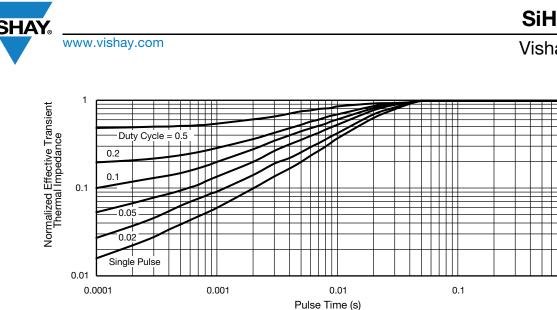
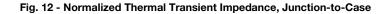


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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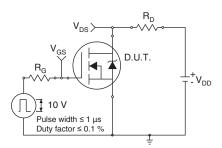


Fig. 13 - Switching Time Test Circuit

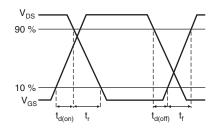


Fig. 14 - Switching Time Waveforms

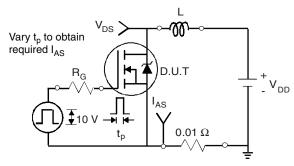


Fig. 15 - Unclamped Inductive Test Circuit

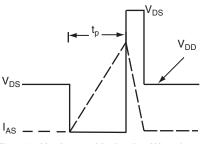


Fig. 16 - Unclamped Inductive Waveforms

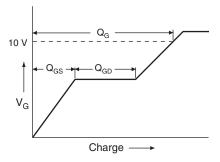


Fig. 17 - Basic Gate Charge Waveform

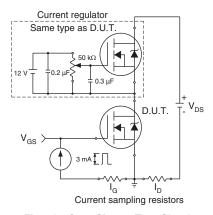


Fig. 18 - Gate Charge Test Circuit

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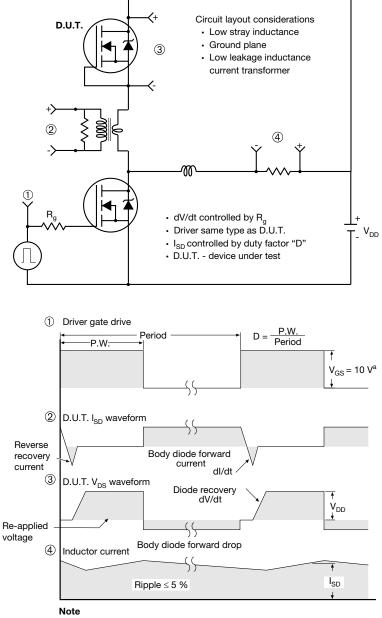
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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